The Topaz SignatureGem® LCD 1x5 is an advanced electronic signature pad with backlit transflective LCD that displays “electronic ink” under the pen tip during signing.

Bundled secure software APIs provide for interactive text, graphics, and pen-tap hotspots and checkboxes which enable users to navigate screens and select preferred options.

**BENEFITS**

- Rugged signing area for **long life**
- LCD display for **customization**
- Small size and weight for **portability**
- High-quality **biometric and forensic** capture
- Topaz software suite bundled at **no additional cost** for complete signing and signature solution customization techniques

**MODELS & DESCRIPTIONS**

- **T-L462-HSB-R**
  - USB
- **T-LBK462-HSB-R**
  - USB
  - Backlit
- **T-LBK462-BSB-R**
  - Virtual Serial via USB
  - Backlit
- **T-L462-B-R**
  - Serial
- **T-LBK462-B-R**
  - Serial
  - Backlit

**SPECIFICATIONS**

- **Warranty**
  - 3-years, with renewal option
BUNDLED DEVELOPER’S TOOLS

- SigPlus® Pro ActiveX: Create applications using ActiveX or view electronically signed documents.
- SigPlus Pro Java: Available as a native Java bean.
- SigPlus Pro C++: Create applications in C.
- SigPlus Pro .NET: Native assembly for the .NET environment.
- pDoc® SDKs: Create applications to capture/embed eSignatures in digital signature fields in PDF documents.

BUNDLED UTILITIES & PLUG-INS

- pDoc Signer®: Create fillable forms and capture eSignatures in PDF documents or fillable forms.
- SigTool Imager Plus™: Make images from eSignatures.
- SignMeln™: HIPAA-compatible software for front-desk sign-in.
- Microsoft Office: For signing in Word and Excel.
- Adobe Acrobat: Add and view signatures in PDFs using Acrobat.
- OPOS Driver: Signature pad drivers for OPOS systems.

PAD’S REMOTE USAGE OPTIONS

- Virtual Serial: "BSB" signature pads.
- Serial: "B" signature pads.
- SigSock™: "HSB" signature pads.

BUNDLED SERVER/BROWSER TOOLS

- SigWeb™: Allows for rapid integration of signature capture functionality into a web application.
- eSign Emcee®: Incorporate eSignatures into existing document-processing work flows.

BUNDLED UTILITIES & PLUG-INS

SPECIFICATIONS

Sensor Type
- Tempered glass surface
- Rated to 2 million signatures
- High-performance E/M digitizer

Pen Type
- Active low-power
- Rugged E/M
- Battery-less pen

Resolution & Conversion Rate
- Exceeds industry standards
- Programmable PPI

Dimensions
- 6.0” x 3.8” x 1.4”
- 152mm x 95mm x 36mm

Signing Area
- 4.4” x 1.3”
- 112mm x 33mm

Authentication Capability
- Forensic quality .SIG data capable of examination and authentication with Topaz software

VERIFICATION SOFTWARE

- SigCompare™: Visually verify eSignatures without the need to create or store templates.
- SigAnalyze®: Available to forensic document examiners with an active signature dispute.

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